# **ESP-WROOM-32** Datasheet



# Espressif Systems

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# About This Guide

This document provides the specifications for the ESP-WROOM-32 module.

### **Release Notes**

| Date   | Version | Release notes   |  |  |
|--|---------|---|--|--|
| 2016.08  | V1.0    | First release.  |  |  |
| 2016.11  | V1.1    | Updated Chapter 6 Schematics.   |  |  |
| 2016.11  | V1.2    | Added Figure 7 Peripheral Schematics.   |  |  |
| 2016.12  | V1.3    | Updated Section 2.1 Pin Layout.   |  |  |
|  |         | Updated Chapter 1 Preface;  |  |  |
|  |         | Updated Chapter 2 Pin Definitions;  |  |  |
|  |         | Updated Chapter 3 Functional Description;   |  |  |
| 2017.03  | V1.4    | Updated Table Recommended Operating Conditions;   |  |  |
|  |         | Updated Table 9 Wi-Fi Radio Characteristics;  |  |  |
|  |         | Updated Section 5.4 Reflow Profile;   |  |  |
|  |         | Added Chapter 9 Learning Resources.   |  |  |
|  |         | Updated Section 2.2 Pin Description;  |  |  |
| 2017.03  | V1.5    | Updated Section 3.2 External Flash and SRAM;  |  |  |
|  |         | Updated Section 4.1 Peripherals and Sensors Description.                                  |  |  |
| 2017.04  | V1.6    | Added Figure 2 Reflow Profile.  |  |  |
|  |         | Added the module's dimensional tolerance;   |  |  |
| 2017.04  | V1.7    | Changed the input impedance value of 50 $\!\Omega$ in Table 9 Wi-Fi Radio Characteristics |  |  |
|  |         | to output impedance value of 30+j10 $\Omega$ .  |  |  |
| 2017.05  | V1.8    | Updated Figure 1 Top and Side View of ESP-WROOM-32.                                       |  |  |
| 2017.06 V1.9   |         | Added a note to Section 2.1 Pin Layout;   |  |  |
|  |         | Updated Section 3.3 Crystal Oscillators;  |  |  |
| 2017.00  | V1.0    | Updated Figure 3 ESP-WROOM-32 Schematics;   |  |  |
|  |         | Added Documentation Change Notification.  |  |  |
|  |         | Changed the sensitivity of NZIF receiver to -97 dBm in Table 2;                           |  |  |
|  |         | Updated the dimensions of the module;   |  |  |
| 2017.08  | V2.0    | Updated Table 6 Power Consumption by Power Modes, and added two notes to it;              |  |  |
| 2011.00  | 12.0    | Updated Table 8, 9, 10, 11;   |  |  |
|  |         | Added Chapter 8;  |  |  |
|  |         | Added the link to certification download.   |  |  |
| 2017.09 V2.1 Updated operating voltage/power supply range updated to 2.7 ~ 3.6V; |         | Updated operating voltage/power supply range updated to 2.7 ~ 3.6V;                       |  |  |
| 2011.00  | V2.1    | Updated Chapter 7.  |  |  |
|  |         | Updated the description of the chip's system reset in Section 2.3 Strapping Pins;         |  |  |
|  |         | Deleted "Association sleep pattern" in Table 6 and added notes to Active sleep and        |  |  |
| 2017.10  | V2.2    | Modem-sleep;  |  |  |
|  |         | Updated the note to Figure 4 Peripheral Schematics;                                       |  |  |
|  |         | Added discharge circuit for VDD33 rail in Chapter 7 and a note to it.                     |  |  |

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## 1. Overview

ESP-WROOM-32 is a powerful, generic Wi-Fi+BT+BLE MCU module that targets a wide variety of applications, ranging from low-power sensor networks to the most demanding tasks, such as voice encoding, music streaming and MP3 decoding.

At the core of this module is the ESP32-D0WDQ6 chip\*. The chip embedded is designed to be scalable and adaptive. There are two CPU cores that can be individually controlled, and the clock frequency is adjustable from 80 MHz to 240 MHz. The user may also power off the CPU and make use of the low-power co-processor to constantly monitor the peripherals for changes or crossing of thresholds. ESP32 integrates a rich set of peripherals, ranging from capacitive touch sensors, Hall sensors, low-noise sense amplifiers, SD card interface, Ethernet, high-speed SPI, UART, I2S and I2C.

#### Note:

\* For details on the part number of the ESP32 series, please refer to the document ESP32 Datasheet.

The integration of Bluetooth, Bluetooth LE and Wi-Fi ensures that a wide range of applications can be targeted, and that the module is future proof: using Wi-Fi allows a large physical range and direct connection to the internet through a Wi-Fi router, while using Bluetooth allows the user to conveniently connect to the phone or broadcast low energy beacons for its detection. The sleep current of the ESP32 chip is less than 5  $\mu$ A, making it suitable for battery powered and wearable electronics applications. ESP32 supports a data rate of up to 150 Mbps, and 20.5 dBm output power at the antenna to ensure the widest physical range. As such the chip does offer industry-leading specifications and the best performance for electronic integration, range, power consumption, and connectivity.

The operating system chosen for ESP32 is freeRTOS with LwIP; TLS 1.2 with hardware acceleration is built in as well. Secure (encrypted) over the air (OTA) upgrade is also supported, so that developers can continually upgrade their products even after their release.

Table 2 provides the specifications of ESP-WROOM-32.

| Categories | Items            | Specifications                                      |  |
|------------|------------------|---|--|
|            | RF certification | FCC/CE/IC/TELEC/KCC/SRRC/NCC                        |  |
|            |                  | 802.11 b/g/n/e/i (802.11n up to 150 Mbps)           |  |
| Wi-Fi      | Protocols        | A-MPDU and A-MSDU aggregation and 0.4 $\mu$ s guard |  |
|            |                  | interval support                                    |  |
|            | Frequency range  | 2.4 ~ 2.5 GHz                                       |  |
|            | Protocols        | Bluetooth v4.2 BR/EDR and BLE specification         |  |
|            |                  | NZIF receiver with -97 dBm sensitivity              |  |
| Bluetooth  | Radio            | Class-1, class-2 and class-3 transmitter            |  |
|            |                  | AFH   |  |
|            | Audio            | CVSD and SBC  |  |

### Table 2: ESP-WROOM-32 Specifications

| Categories | Items                          | Specifications                                    |  |  |
|------------|--------------------------------|---|--|--|
|            |                                | SD card, UART, SPI, SDIO, I2C, LED PWM, Motor     |  |  |
|            | Module interface               | PWM, I2S, IR                                      |  |  |
|            |                                | GPIO, capacitive touch sensor, ADC, DAC, LNA pre- |  |  |
|            |                                | amplifier   |  |  |
|            | On-chip sensor                 | Hall sensor, temperature sensor                   |  |  |
|            | On-board clock                 | 40 MHz crystal                                    |  |  |
| Hardware   | Operating voltage/Power supply | 2.7 ~ 3.6V  |  |  |
|            | Operating current              | Average: 80 mA                                    |  |  |
|            | Minimum current delivered by   | 500 mA  |  |  |
|            | power supply                   | 500 mA  |  |  |
|            | Operating temperature range    | -40°C ~ +85°C                                     |  |  |
|            | Ambient temperature range      | Normal temperature                                |  |  |
|            | Package size                   | 18±0.2 mm x 25.5±0.2 mm x 3.1±0.15 mm             |  |  |
|            | Wi-Fi mode                     | Station/SoftAP/SoftAP+Station/P2P                 |  |  |
|            | Wi-Fi Security                 | WPA/WPA2/WPA2-Enterprise/WPS                      |  |  |
|            | Encryption                     | AES/RSA/ECC/SHA                                   |  |  |
|            | Firmware upgrade               | UART Download / OTA (download and write firmware  |  |  |
| Software   |                                | via network or host)                              |  |  |
|            | Software development           | Supports Cloud Server Development / SDK for cus-  |  |  |
|            |                                | tom firmware development                          |  |  |
|            | Network protocols              | IPv4, IPv6, SSL, TCP/UDP/HTTP/FTP/MQTT            |  |  |
|            | User configuration             | AT instruction set, cloud server, Android/iOS app |  |  |

# 2. Pin Definitions

## 2.1 Pin Layout

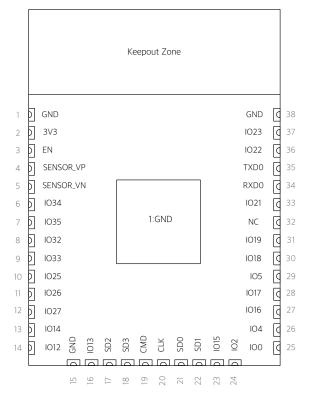


Figure 1: ESP-WROOM-32 Pin layout

## 2.2 Pin Description

ESP-WROOM-32 has 38 pins. See pin definitions in Table 3.

### Table 3: Pin Definitions

| Name      | No. | Туре | Function   |
|-----------|-----|------|--|
| GND       | 1   | Р    | Ground   |
| 3V3       | 2   | Р    | Power supply.  |
| EN        | 3   | 1    | Chip-enable signal. Active high.                                     |
| SENSOR_VP | 4   | I    | GPIO36, SENSOR_VP, ADC_H, ADC1_CH0, RTC_GPIO0                        |
| SENSOR_VN | 5   | I    | GPIO39, SENSOR_VN, ADC1_CH3, ADC_H, RTC_GPIO3                        |
| IO34      | 6   | I    | GPIO34, ADC1_CH6, RTC_GPIO4  |
| IO35      | 7   | I    | GPIO35, ADC1_CH7, RTC_GPIO5  |
| 1032      | 8   | I/O  | GPIO32, XTAL_32K_P (32.768 kHz crystal oscillator input), ADC1_CH4,  |
| 1032      | 0   | 1/0  | TOUCH9, RTC_GPIO9  |
| 1033      | 9   | I/O  | GPIO33, XTAL_32K_N (32.768 kHz crystal oscillator output), ADC1_CH5, |
| 1033      | 9   | 1/0  | TOUCH8, RTC_GPIO8  |
| IO25      | 10  | I/O  | GPIO25, DAC_1, ADC2_CH8, RTC_GPIO6, EMAC_RXD0                        |
| IO26      | 11  | I/O  | GPIO26, DAC_2, ADC2_CH9, RTC_GPIO7, EMAC_RXD1                        |
| IO27      | 12  | I/O  | GPIO27, ADC2_CH7, TOUCH7, RTC_GPIO17, EMAC_RX_DV                     |

| Name     | No. | Туре | Function  |  |  |  |
|----------|-----|------|---|--|--|--|
| IO14     | 10  | I/O  | GPIO14, ADC2_CH6, TOUCH6, RTC_GPIO16, MTMS, HSPICLK,    |  |  |  |
| 1014     | 13  | 1/0  | HS2_CLK, SD_CLK, EMAC_TXD2                              |  |  |  |
| IO12     | 14  | I/O  | GPIO12, ADC2_CH5, TOUCH5, RTC_GPIO15, MTDI, HSPIQ,      |  |  |  |
|          | 14  | 1/0  | HS2_DATA2, SD_DATA2, EMAC_TXD3                          |  |  |  |
| GND      | 15  | Р    | Ground  |  |  |  |
| IO13     | 16  | I/O  | GPIO13, ADC2_CH4, TOUCH4, RTC_GPIO14, MTCK, HSPID,      |  |  |  |
|          | 10  | 1/0  | HS2_DATA3, SD_DATA3, EMAC_RX_ER                         |  |  |  |
| SHD/SD2* | 17  | I/O  | GPIO9, SD_DATA2, SPIHD, HS1_DATA2, U1RXD                |  |  |  |
| SWP/SD3* | 18  | I/O  | GPIO10, SD_DATA3, SPIWP, HS1_DATA3, U1TXD               |  |  |  |
| SCS/CMD* | 19  | I/O  | GPIO11, SD_CMD, SPICS0, HS1_CMD, U1RTS                  |  |  |  |
| SCK/CLK* | 20  | I/O  | GPIO6, SD_CLK, SPICLK, HS1_CLK, U1CTS                   |  |  |  |
| SDO/SD0* | 21  | I/O  | GPIO7, SD_DATA0, SPIQ, HS1_DATA0, U2RTS                 |  |  |  |
| SDI/SD1* | 22  | I/O  | GPIO8, SD_DATA1, SPID, HS1_DATA1, U2CTS                 |  |  |  |
| 1015     | 23  | I/O  | GPI015, ADC2_CH3, TOUCH3, MTDO, HSPICS0, RTC_GPI013,    |  |  |  |
| IO15     | 23  | 1/0  | HS2_CMD, SD_CMD, EMAC_RXD3                              |  |  |  |
| 102      | 24  | I/O  | GPIO2, ADC2_CH2, TOUCH2, RTC_GPIO12, HSPIWP, HS2_DATA0, |  |  |  |
| 102      | 24  | 1/0  | SD_DATA0  |  |  |  |
| 100      | 25  | I/O  | GPIO0, ADC2_CH1, TOUCH1, RTC_GPIO11, CLK_OUT1,          |  |  |  |
|          | 20  | 1/0  | EMAC_TX_CLK   |  |  |  |
| 104      | 26  | I/O  | GPIO4, ADC2_CH0, TOUCH0, RTC_GPIO10, HSPIHD, HS2_DATA1, |  |  |  |
| 104      | 20  | 1/0  | SD_DATA1, EMAC_TX_ER                                    |  |  |  |
| IO16     | 27  | I/O  | GPIO16, HS1_DATA4, U2RXD, EMAC_CLK_OUT                  |  |  |  |
| IO17     | 28  | I/O  | GPIO17, HS1_DATA5, U2TXD, EMAC_CLK_OUT_180              |  |  |  |
| 105      | 29  | I/O  | GPIO5, VSPICS0, HS1_DATA6, EMAC_RX_CLK                  |  |  |  |
| IO18     | 30  | I/O  | GPIO18, VSPICLK, HS1_DATA7                              |  |  |  |
| IO19     | 31  | I/O  | GPIO19, VSPIQ, UOCTS, EMAC_TXD0                         |  |  |  |
| NC       | 32  | -    | -   |  |  |  |
| IO21     | 33  | I/O  | GPIO21, VSPIHD, EMAC_TX_EN                              |  |  |  |
| RXD0     | 34  | I/O  | GPIO3, U0RXD, CLK_OUT2                                  |  |  |  |
| TXD0     | 35  | I/O  | GPIO1, U0TXD, CLK_OUT3, EMAC_RXD2                       |  |  |  |
| 1022     | 36  | I/O  | GPIO22, VSPIWP, UORTS, EMAC_TXD1                        |  |  |  |
| 1023     | 37  | I/O  | GPIO23, VSPID, HS1_STROBE                               |  |  |  |
| GND      | 38  | Р    | Ground  |  |  |  |

#### Note:

\* Pins SCK/CLK, SDO/SD0, SDI/SD1, SHD/SD2, SWP/SD3 and SCS/CMD, namely, GPIO6 to GPIO11 are connected to the integrated SPI flash integrated on ESP-WROOM-32 and are not recommended for other uses.

### 2.3 Strapping Pins

Please refer to ESP-WROOM-32 schematics.

ESP32 has five strapping pins, which can be seen in Section 6 Schematics:

• MTDI

- GPI00
- GPIO2
- MTDO
- GPI05

Software can read the value of these five bits from the register "GPIO\_STRAPPING".

During the chip's system reset (power-on reset, RTC watchdog reset and brownout reset), the latches of the strapping pins sample the voltage level as strapping bits of "0" or "1", and hold these bits until the chip is powered down or shut down. The strapping bits configure the device boot mode, the operating voltage of VDD\_SDIO and other system initial settings.

Each strapping pin is connected with its internal pull-up/pull-down during the chip reset. Consequently, if a strapping pin is unconnected or the connected external circuit is high-impendence, the internal weak pull-up/pull-down will determine the default input level of the strapping pins.

To change the strapping bit values, users can apply the external pull-down/pull-up resistances, or apply the host MCU's GPIOs to control the voltage level of these pins when powering on ESP32.

After reset, the strapping pins work as the normal functions pins.

Refer to Table 4 for detailed boot modes' configuration by strapping pins.

|       | Voltage of Internal LDO (VDD_SDIO) |                                       |                       |                     |                    |  |  |
|-------|------------------------------------|---------------------------------------|-----------------------|---------------------|--------------------|--|--|
| Pin   | Default                            | 3.5                                   | 3V                    | 1.8V                |                    |  |  |
| MTDI  | Pull-down                          | (                                     | )                     | -                   | 1                  |  |  |
|       |                                    |                                       | Booting Mode          |                     |                    |  |  |
| Pin   | Default                            | SPI                                   | Boot                  | Downlo              | ad Boot            |  |  |
| GPIO0 | Pull-up                            | -                                     | 1                     | (                   | )                  |  |  |
| GPIO2 | Pull-down                          | Don't                                 | -care                 | 0                   |                    |  |  |
|       |                                    | Debugging                             | g Log on U0TXD During | g Booting           |                    |  |  |
| Pin   | Default                            | UOTXD                                 | Toggling              | UOTXE               | ) Silent           |  |  |
| MTDO  | Pull-up                            | -                                     | 1                     | 0                   |                    |  |  |
|       |                                    |                                       | Timing of SDIO Slave  |                     |                    |  |  |
| Pin   | Default                            | Falling-edge Input                    | Falling-edge Input    | Rising-edge Input   | Rising-edge Input  |  |  |
| ГШ    | Delault                            | Falling-edge OutputRising-edge Output |                       | Falling-edge Output | Rising-edge Output |  |  |
| MTDO  | Pull-up                            | 0                                     | 0                     | 1                   | 1                  |  |  |
| GPIO5 | Pull-up                            | 0                                     | 1                     | 0                   | 1                  |  |  |

#### Table 4: Strapping Pins

Note:

Firmware can configure register bits to change the settings of "Voltage of Internal LDO (VDD\_SDIO)" and "Timing of SDIO Slave" after booting.

## 3. Functional Description

This chapter describes the modules and functions integrated in ESP-WROOM-32.

## 3.1 CPU and Internal Memory

ESP32-D0WDQ6 contains two low-power Xtensa<sup>®</sup> 32-bit LX6 microprocessors. The internal memory includes:

- 448 kB of ROM for booting and core functions.
- 520 kB (8 kB RTC FAST Memory included) of on-chip SRAM for data and instruction.
  - 8 kB of SRAM in RTC, which is called RTC FAST Memory and can be used for data storage; it is accessed by the main CPU during RTC Boot from the Deep-sleep mode.
- 8 kB of SRAM in RTC, which is called RTC SLOW Memory and can be accessed by the co-processor during the Deep-sleep mode.
- 1 kbit of eFuse, of which 256 bits are used for the system (MAC address and chip configuration) and the remaining 768 bits are reserved for customer applications, including Flash-Encryption and Chip-ID.

## 3.2 External Flash and SRAM

ESP32 supports up to four 16-MB of external QSPI flash and SRAM with hardware encryption based on AES to protect developers' programs and data.

ESP32 can access the external QSPI flash and SRAM through high-speed caches.

- Up to 16 MB of external flash are memory-mapped onto the CPU code space, supporting 8, 16 and 32-bit access. Code execution is supported.
- Up to 8 MB of external flash/SRAM are memory-mapped onto the CPU data space, supporting 8, 16 and 32-bit access. Data-read is supported on the flash and SRAM. Data-write is supported on the SRAM.

ESP-WROOM-32 integrates 4 MB of external SPI flash. The 4-MB SPI flash can be memory-mapped onto the CPU code space, supporting 8, 16 and 32-bit access. Code execution is supported. The integrated SPI flash is connected to GPIO6, GPIO7, GPIO8, GPIO9, GPIO10 and GPIO11. These six pins cannot be used as regular GPIO.

## 3.3 Crystal Oscillators

The ESP32 Wi-Fi/BT firmware can only support 40 MHz crystal oscillator for now.

## 3.4 RTC and Low-Power Management

With the use of advanced power management technologies, ESP32 can switch between different power modes (see Table 5).

- Power modes
  - Active mode: The chip radio is powered on. The chip can receive, transmit, or listen.
  - Modem-sleep mode: The CPU is operational and the clock is configurable. The Wi-Fi/Bluetooth baseband and radio are disabled.
  - Light-sleep mode: The CPU is paused. The RTC memory and RTC peripherals, as well as the ULP co-processor are running. Any wake-up events (MAC, host, RTC timer, or external interrupts) will wake up the chip.
  - Deep-sleep mode: Only the RTC memory and RTC peripherals are powered on. Wi-Fi and Bluetooth connection data are stored in the RTC memory. The ULP co-processor can work.
  - Hibernation mode: The internal 8-MHz oscillator and ULP co-processor are disabled. The RTC recovery
    memory is powered down. Only one RTC timer on the slow clock and some RTC GPIOs are active.
    The RTC timer or the RTC GPIOs can wake up the chip from the Hibernation mode.
- Sleep Patterns
  - Association sleep pattern: The power mode switches between the Active mode, Modem- and Lightsleep mode during this sleep pattern. The CPU, Wi-Fi, Bluetooth, and radio are woken up at predetermined intervals to keep Wi-Fi/BT connections alive.
  - ULP sensor-monitored pattern: The main CPU is in the Deep-sleep mode. The ULP co-processor takes sensor measurements and wakes up the main system, based on the data collected from sensors.

| Power mode                          | Active                    | Modem-sleep | Light-sleep | Deep-sleep                       | Hibernation |
|-------------------------------------|---------------------------|-------------|-------------|----------------------------------|-------------|
| Sleep pattern                       | Association sleep pattern |             | pattern     | ULP sensor-<br>monitored pattern | -           |
| CPU                                 | ON                        | ON          | PAUSE       | OFF                              | OFF         |
| Wi-Fi/BT baseband and radio         | ON                        | OFF         | OFF         | OFF                              | OFF         |
| RTC memory and RTC pe-<br>ripherals | ON                        | ON          | ON          | ON                               | OFF         |
| ULP co-processor                    | ON                        | ON          | ON          | ON/OFF                           | OFF         |

#### Table 5: Functionalities Depending on the Power Modes

The power consumption varies with different power modes/sleep patterns and work statuses of functional modules. Please see Table 6 for details.

| Table 6: Power Consumption by F | Power Modes |
|---------------------------------|-------------|
|---------------------------------|-------------|

| Power mode          | Description                                | Power consumption                |  |
|---------------------|--|----------------------------------|--|
|                     | Wi-Fi Tx packet 14 dBm ~ 19.5 dBm          |                                  |  |
| Active (RF working) | Wi-Fi / BT Tx packet 0 dBm                 | Please refer to ESP32 Datasheet. |  |
|                     | Wi-Fi / BT Rx and listening                |                                  |  |
|                     | Association sleep pattern (by Light-sleep) | 1 mA ~ 4 mA @DTIM3               |  |

| Power mode                         | Description  | Power consumption                  |
|------------------------------------|--|------------------------------------|
|                                    |  | Max speed 240 MHz: 30 mA ~ 50 mA   |
| Modem-sleep The CPU is powered on. |  | Normal speed 80 MHz: 20 mA ~ 25 mA |
|                                    |  | Slow speed 2 MHz: 2 mA ~ 4 mA      |
| Light-sleep                        | -  | 0.8 mA                             |
|                                    | The ULP co-processor is powered on.                  | 150 µA                             |
| Deep-sleep                         | ULP sensor-monitored pattern                         | 100 µA @1% duty                    |
|                                    | RTC timer + RTC memory                               | 10 μA                              |
| Hibernation                        | RTC timer only                                       | 5 μΑ                               |
| Power off                          | CHIP_PU is set to low level, the chip is powered off | 0.1 μA                             |

#### Note:

- When Wi-Fi is enabled, the chip switches between Active and Modem-sleep mode. Therefore, power consumption changes accordingly.
- In Modem-sleep mode, the CPU frequency changes automatically. The frequency depends on the CPU load and the peripherals used.
- During Deep-sleep, when the ULP co-processor is powered on, peripherals such as GPIO and I2C are able to work.
- When the system works in the ULP sensor-monitored pattern, the ULP co-processor works with the ULP sensor periodically; ADC works with a duty cycle of 1%, so the power consumption is 100 μA.

# 4. Peripherals and Sensors

## 4.1 Peripherals and Sensors Description

### Table 7: Description of Peripherals and Sensors

| Interface            | Signal    | Pin       | Function                                  |  |  |  |
|----------------------|-----------|-----------|---|--|--|--|
|                      | ADC1_CH0  | SENSOR_VP |   |  |  |  |
|                      | ADC1_CH3  | SENSOR_VN |   |  |  |  |
|                      | ADC1_CH4  | IO32      |   |  |  |  |
|                      | ADC1_CH5  | IO33      |   |  |  |  |
|                      | ADC1_CH6  | IO34      |   |  |  |  |
|                      | ADC1_CH7  | IO35      |   |  |  |  |
|                      | ADC2_CH0  | IO4       |   |  |  |  |
| ADC                  | ADC2_CH1  | IO0       | Two 12-bit SAR ADCs                       |  |  |  |
|                      | ADC2_CH2  | IO2       |   |  |  |  |
|                      | ADC2_CH3  | IO15      |   |  |  |  |
|                      | ADC2_CH4  | IO13      |   |  |  |  |
|                      | ADC2_CH5  | IO12      |   |  |  |  |
|                      | ADC2_CH6  | IO14      |   |  |  |  |
|                      | ADC2_CH7  | IO27      |   |  |  |  |
|                      | ADC2_CH8  | IO25      |   |  |  |  |
|                      | ADC2_CH9  | IO26      |   |  |  |  |
| Ultra-Low Noise      | SENSOR_VP | IO36      | Provides about 60 dB gain by using larger |  |  |  |
| Analog Pre-Amplifier | SENSOR_VN | IO39      | capacitors on PCB                         |  |  |  |
| DAC                  | DAC_1     | IO25      | - Two 8-bit DACs                          |  |  |  |
|                      | DAC_2     | IO26      |   |  |  |  |
|                      | TOUCHO    | IO4       |   |  |  |  |
|                      | TOUCH1    | IOO       |   |  |  |  |
|                      | TOUCH2    | 102       |   |  |  |  |
|                      | TOUCH3    | IO15      |   |  |  |  |
| Touch Sensor         | TOUCH4    | IO13      | Capacitive touch sensors                  |  |  |  |
|                      | TOUCH5    | IO12      |   |  |  |  |
|                      | TOUCH6    | IO14      |   |  |  |  |
|                      | TOUCH7    | IO27      |   |  |  |  |
|                      | TOUCH8    | IO33      |   |  |  |  |
|                      | TOUCH9    | IO32      |   |  |  |  |
|                      | HS2_CLK   | MTMS      |   |  |  |  |
|                      | HS2_CMD   | MTDO      |   |  |  |  |
| SD/SDIO/MMC Host     | HS2_DATA0 | 102       | Supports SD memory card V3.01 standard    |  |  |  |
| Controller           | HS2_DATA1 | IO4       |   |  |  |  |
|                      | HS2_DATA2 | MTDI      |   |  |  |  |
|                      | HS2_DATA3 | MTCK      |   |  |  |  |

| Interface | Signal             | Pin        | Function   |
|-----------|--------------------|------------|--|
|           | PWM0_OUT0~2        |            |  |
|           | PWM1_OUT_IN0~2     |            | Three channels of 16 bit timers generate   |
|           | PWM0_FLT_IN0~2     |            | Three channels of 16-bit timers generate<br>PWM waveforms. Each channel has a pair |
| Motor PWM | PWM1_FLT_IN0~2     | Any GPIOs* | of output signals, three fault detection   |
|           | PWM0_CAP_IN0~2     |            | signals, three event-capture signals, and  |
|           | PWM1_CAP_IN0~2     |            | three sync signals.  |
|           | PWM0_SYNC_IN0~2    |            |  |
|           | PWM1_SYNC_IN0~2    |            |  |
| LED PWM   | ledc_hs_sig_out0~7 | Any GPIOs* | 16 independent channels @80 MHz  |
|           | ledc_ls_sig_out0~7 |            | clock/RTC CLK. Duty accuracy: 16 bits.   |
|           | U0RXD_in           |            |  |
|           | U0CTS_in           |            |  |
|           | U0DSR_in           | Any GPIOs* |  |
|           | U0TXD_out          |            |  |
|           | UORTS_out          |            |  |
|           | U0DTR_out          |            |  |
| UART      | U1RXD_in           |            | Two UART devices with hardware   |
|           | U1CTS_in           |            | flow-control and DMA   |
|           | U1TXD_out          |            |  |
|           | U1RTS_out          |            |  |
|           | U2RXD_in           |            |  |
|           | U2CTS_in           |            |  |
|           | U2TXD_out          |            |  |
|           | U2RTS_out          |            |  |
|           | I2CEXT0_SCL_in     |            |  |
|           | I2CEXT0_SDA_in     |            |  |
|           | I2CEXT1_SCL_in     |            |  |
| 12C       | I2CEXT1_SDA_in     | Any GPIOs* | Two I2C devices in slave or master modes   |
|           | I2CEXT0_SCL_out    |            |  |
|           | I2CEXT0_SDA_out    |            |  |
|           | I2CEXT1_SCL_out    |            |  |
|           | I2CEXT1_SDA_out    |            |  |

| Interface         | Signal             | Pin        | Function                                  |
|-------------------|--------------------|------------|---|
|                   | I2S0I_DATA_in0~15  |            |   |
|                   | I2S00_BCK_in       |            |   |
|                   | I2S00_WS_in        |            |   |
|                   | I2S0I_BCK_in       |            |   |
|                   | I2S0I_WS_in        |            |   |
|                   | I2S0I_H_SYNC       |            |   |
|                   | I2SOI_V_SYNC       |            |   |
|                   | I2S0I_H_ENABLE     |            |   |
|                   | I2S00_BCK_out      |            |   |
|                   | I2S0O_WS_out       |            |   |
|                   | I2S0I_BCK_out      |            |   |
|                   | I2SOI_WS_out       |            | Stereo input and output from/to the audio |
| I2S               | I2SOO_DATA_out0~23 | Any GPIOs* | codec, and parallel LCD data output       |
|                   | I2S1I_DATA_in0~15  |            |   |
|                   | I2S10_BCK_in       |            |   |
|                   | I2S10_WS_in        |            |   |
|                   | I2S1I_BCK_in       |            |   |
|                   | I2S1I_WS_in        |            |   |
|                   | I2S1I_H_SYNC       |            |   |
|                   | I2S1I_V_SYNC       |            |   |
|                   | I2S1I_H_ENABLE     |            |   |
|                   | I2S1O_BCK_out      |            |   |
|                   | I2S1O_WS_out       |            |   |
|                   | I2S1I_BCK_out      |            |   |
|                   | I2S1I_WS_out       |            |   |
|                   | I2S1O_DATA_out0~23 |            |   |
| Remote Controller | RMT_SIG_IN0~7      | Any GPIOs* | Eight channels of IR transmitter and      |
|                   | RMT_SIG_OUT0~7     |            | receiver for various waveforms            |

| Interface       | Signal           | Pin        | Function  |  |  |  |
|-----------------|------------------|------------|---|--|--|--|
|                 | SPIHD            | SHD/SD2    |   |  |  |  |
|                 | SPIWP            | SWP/SD3    |   |  |  |  |
|                 | SPICS0           | SCS/CMD    |   |  |  |  |
|                 | SPICLK           | SCK/CLK    |   |  |  |  |
|                 | SPIQ             | SDO/SD0    |   |  |  |  |
|                 | SPID             | SDI/SD1    |   |  |  |  |
|                 | HSPICLK          | IO14       |   |  |  |  |
|                 | HSPICS0          | IO15       | Supports Standard SPI, Dual SPI, and            |  |  |  |
| Parallel QSPI   | HSPIQ            | IO12       | Quad SPI that can be connected to the           |  |  |  |
|                 | HSPID            | IO13       | external flash and SRAM                         |  |  |  |
|                 | HSPIHD           | IO4        |   |  |  |  |
|                 | HSPIWP           | IO2        |   |  |  |  |
|                 | VSPICLK          | IO18       |   |  |  |  |
|                 | VSPICS0          | IO5        |   |  |  |  |
|                 | VSPIQ            | IO19       |   |  |  |  |
|                 | VSPID            | IO23       |   |  |  |  |
|                 | VSPIHD           | IO21       |   |  |  |  |
|                 | VSPIWP           | IO22       |   |  |  |  |
|                 | HSPIQ_in/_out    |            | Standard SPI consists of clock,                 |  |  |  |
|                 | HSPID_in/_out    |            | chip-select, MOSI and MISO. These SPIs          |  |  |  |
|                 | HSPICLK_in/_out  |            | can be connected to LCD and other               |  |  |  |
|                 | HSPI_CS0_in/_out |            | external devices. They support the              |  |  |  |
|                 | HSPI_CS1_out     |            | following features:                             |  |  |  |
| General Purpose | HSPI_CS2_out     | Any GPIOs* | • both master and slave modes;                  |  |  |  |
| SPI             | VSPIQ_in/_out    | ,          | • 4 sub-modes of the SPI format                 |  |  |  |
|                 | VSPID_in/_out    |            | transfer that depend on the clock               |  |  |  |
|                 | VSPICLK_in/_out  |            | phase (CPHA) and clock polarity                 |  |  |  |
|                 | VSPI_CS0_in/_out |            | (CPOL) control;                                 |  |  |  |
|                 | VSPI_CS1_out     |            | configurable SPI frequency;                     |  |  |  |
|                 | VSPI_CS2_out     |            | • up to 64 bytes of FIFO and DMA.               |  |  |  |
|                 | MTDI             | IO12       |   |  |  |  |
| JTAG            | MTCK             | IO13       | <ul> <li>JTAG for software debugging</li> </ul> |  |  |  |
|                 | MTMS             | IO14       | o mailor soltware debugging                     |  |  |  |
|                 | MTDO             | IO15       | 1   |  |  |  |

| Interface  | Signal           | Pin        | Function                             |
|------------|------------------|------------|--------------------------------------|
|            | SD_CLK           | 106        |                                      |
|            | SD_CMD           | IO11       | SDIO interface that conforms to the  |
| SDIO Slave | SD_DATA0         | 107        | industry standard SDIO 2.0 card      |
| ODIO Olave | SD_DATA1         | IO8        | specification.                       |
|            | SD_DATA2         | 109        |                                      |
|            | SD_DATA3         | IO10       |                                      |
|            | EMAC_TX_CLK      | 100        |                                      |
|            | EMAC_RX_CLK      | IO5        |                                      |
|            | EMAC_TX_EN       | IO21       |                                      |
|            | EMAC_TXD0        | IO19       |                                      |
|            | EMAC_TXD1        | IO22       |                                      |
|            | EMAC_TXD2        | IO14       |                                      |
|            | EMAC_TXD3        | IO12       |                                      |
|            | EMAC_RX_ER       | IO13       |                                      |
|            | EMAC_RX_DV       | 1027       |                                      |
|            | EMAC_RXD0        | IO25       |                                      |
| EMAC       | EMAC_RXD1        | IO26       | Ethernet MAC with MII/RMII interface |
|            | EMAC_RXD2        | TXD0       |                                      |
|            | EMAC_RXD3        | IO15       |                                      |
|            | EMAC_CLK_OUT     | IO16       |                                      |
|            | EMAC_CLK_OUT_180 | IO17       |                                      |
|            | EMAC_TX_ER       | IO4        |                                      |
|            | EMAC_MDC_out     | Any GPIOs* |                                      |
|            | EMAC_MDI_in      | Any GPIOs* |                                      |
|            | EMAC_MDO_out     | Any GPIOs* |                                      |
|            | EMAC_CRS_out     | Any GPIOs* |                                      |
|            | EMAC_COL_out     | Any GPIOs* |                                      |

#### Note:

• Functions of Motor PWM, LED PWM, UART, I2C, I2S, general purpose SPI and Remote Controller can be configured to any GPIO except GPIO6, GPIO7, GPIO8, GPIO9, GPIO10 and GPIO11.

• For the items marked with "Any GPIOs\*" in the "Pin" column, users should note that GPIO6, GPIO7, GPIO8, GPIO9, GPIO10 and GPIO11 are connected to the integrated SPI flash of ESP-WROOM-32 and are not recommended for other uses.

## 5. Electrical Characteristics

#### Note:

The specifications in this chapter have been tested under the following general condition: VDD = 3.3V,  $T_A = 27^{\circ}$ C, unless otherwise specified.

## 5.1 Absolute Maximum Ratings

#### Parameter Symbol Min Тур Max Unit VDD 2.7 3.3 3.6 V Power supply Minimum current delivered by 0.5 А $|_{VDD}$ \_ power supply -0.3 \_ $0.25 \times V_{IO}^{1}$ V Input low voltage $V_{IL}$ $0.75 \times V_{IO}^{1}$ $V_{IO}^{1}+0.3$ V Input high voltage $V_{IH}$ \_ Input leakage current $|_{IL}$ -\_ 50 nΑ 2 рF Input pin capacitance $C_{pad}$ \_ -Output low voltage \_ $0.1 \times V_{IO}^{1}$ V $V_{OL}$ \_ $0.8 \times V_{IO}^{1}$ V Output high voltage $V_{OH}$ --Maximum output drive capability -\_ 40 $|_{MAX}$ mΑ °C -40 \_ 85 Storage temperature range $\mathsf{T}_{STR}$ °C Operating temperature range $\mathsf{T}_{OPR}$ -40 \_ 85

#### Table 8: Absolute Maximum Ratings

1. V<sub>IO</sub> is the power supply for a specific pad. More details can be found in the <u>ESP32 Datasheet</u>, Appendix IO\_MUX. For example, the power supply for SD\_CLK is the VDD\_SDIO.

### 5.2 Wi-Fi Radio

#### Table 9: Wi-Fi Radio Characteristics

| Description                      | Min         | Typical | Max  | Unit |
|----------------------------------|-------------|---------|------|------|
| Input frequency                  | 2412        | -       | 2484 | MHz  |
| Input reflection                 | -           | -       | -10  | dB   |
|                                  | Tx power    |         |      |      |
| Output power of PA for 72.2 Mbps | 13          | 14      | 15   | dBm  |
| Output power of PA for 11b mode  | 19.5        | 20      | 20.5 | dBm  |
|                                  | Sensitivity | ,       |      |      |
| DSSS, 1 Mbps                     | -           | -98     | -    | dBm  |
| CCK, 11 Mbps                     | -           | -91     | -    | dBm  |
| OFDM, 6 Mbps                     | -           | -93     | -    | dBm  |
| OFDM, 54 Mbps                    | -           | -75     | -    | dBm  |
| HT20, MCS0                       | -           | -93     | -    | dBm  |
| HT20, MCS7                       | -           | -73     | -    | dBm  |

| Description   | Min                        | Typical | Max | Unit |  |  |
|---------------|----------------------------|---------|-----|------|--|--|
| HT40, MCS0    | -                          | -90     | -   | dBm  |  |  |
| HT40, MCS7    | -                          | -70     | -   | dBm  |  |  |
| MCS32         | -                          | -89     | -   | dBm  |  |  |
| Ad            | Adjacent channel rejection |         |     |      |  |  |
| OFDM, 6 Mbps  | -                          | 37      | -   | dB   |  |  |
| OFDM, 54 Mbps | -                          | 21      | -   | dB   |  |  |
| HT20, MCS0    | -                          | 37      | -   | dB   |  |  |
| HT20, MCS7    | -                          | 20      | -   | dB   |  |  |

## 5.3 BLE Radio

### 5.3.1 Receiver

### Table 10: Receiver Characteristics - BLE

| Parameter                          | Conditions          | Min | Тур | Max | Unit |
|------------------------------------|---------------------|-----|-----|-----|------|
| Sensitivity @30.8% PER             | -                   | -   | -97 | -   | dBm  |
| Maximum received signal @30.8% PER | -                   | 0   | -   | -   | dBm  |
| Co-channel C/I                     | -                   | -   | +10 | -   | dB   |
|                                    | F = F0 + 1 MHz      | -   | -5  | -   | dB   |
|                                    | F = F0 - 1 MHz      | -   | -5  | -   | dB   |
| Adiagant abannal salaativity C/I   | F = F0 + 2 MHz      | -   | -25 | -   | dB   |
| Adjacent channel selectivity C/I   | F = F0 - 2 MHz      | -   | -35 | -   | dB   |
|                                    | F = F0 + 3 MHz      | -   | -25 | -   | dB   |
|                                    | F = F0 - 3 MHz      | -   | -45 | -   | dB   |
|                                    | 30 MHz ~ 2000 MHz   | -10 | -   | -   | dBm  |
| Out of band blocking performance   | 2000 MHz ~ 2400 MHz | -27 | -   | -   | dBm  |
| Out-of-band blocking performance   | 2500 MHz ~ 3000 MHz | -27 | -   | -   | dBm  |
|                                    | 3000 MHz ~ 12.5 GHz | -10 | -   | -   | dBm  |
| Intermodulation                    | -                   | -36 | -   | -   | dBm  |

### 5.3.2 Transmitter

| Table 11: Transmitter Characteristic | s — BLE |
|--------------------------------------|---------|
|--------------------------------------|---------|

| Parameter              | Conditions | Min | Тур | Max | Unit |
|------------------------|------------|-----|-----|-----|------|
| RF transmit power      | -          | -   | 0   | -   | dBm  |
| Gain control step      | -          | -   | ±3  | -   | dBm  |
| RF power control range | -          | -12 | -   | +12 | dBm  |

| Parameter                         | Conditions       | Min | Тур   | Max | Unit      |
|-----------------------------------|------------------|-----|-------|-----|-----------|
|                                   | F = F0 + 1 MHz   | -   | -14.6 | -   | dBm       |
|                                   | F = F0 - 1 MHz   | -   | -12.7 | -   | dBm       |
|                                   | F = F0 + 2 MHz   | -   | -44.3 | -   | dBm       |
| Adjacent channel transmit power   | F = F0 - 2 MHz   | -   | -38.7 | -   | dBm       |
|                                   | F = F0 + 3 MHz   | -   | -49.2 | -   | dBm       |
|                                   | F = F0 - 3 MHz   | -   | -44.7 | -   | dBm       |
|                                   | F = F0 + > 3 MHz | -   | -50   | -   | dBm       |
|                                   | F = F0 - 3 MHz   | -   | -50   | -   | dBm       |
| $\Delta f1_{avg}$                 | -                | -   | -     | 265 | kHz       |
| $\Delta f_{2\max}$                | -                | 247 | -     | -   | kHz       |
| $\Delta f_{2avg}/\Delta f_{1avg}$ | -                | -   | -0.92 | -   | -         |
| ICFT                              | -                | -   | -10   | -   | kHz       |
| Drift rate                        | -                | -   | 0.7   | -   | kHz/50 μs |
| Drift                             | -                | -   | 2     | -   | kHz       |

## 5.4 Reflow Profile

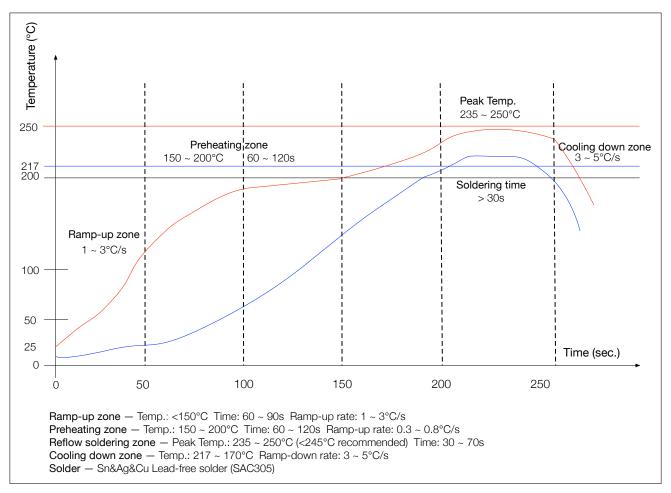


Figure 2: Reflow Profile

# 6. Schematics

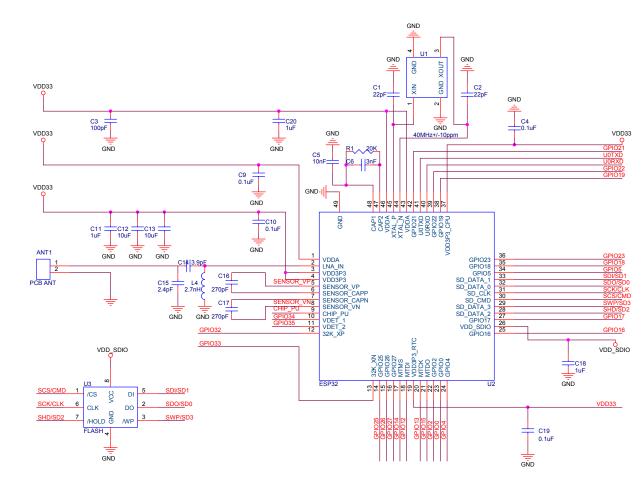


Figure 3: ESP-WROOM-32 Schematics

Pin.15 GND

Pin.16 1013

Pin.17 SD2

Pin.18 SD3

Pin.19 CMD

Pin.20 CLK

Pin.21 SD0

Pin.22 SD1

Pin.23 1015

Pin.24 102

Pin.39 GND

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 $\square$ 

GPIO13

SHD/SD

SWP/SD

SCS/CM

SCK/CLI

SDO/SDI

SDI/SD1

GPIO15

GPIO2

GND

Pin.1 GND

Pin.2 3V3

Pin.6 1034

Pin.7 1035

Pin.8 1032

Pin.9 1033

Pin.10 1025

Pin.11 1026

Pin.12 1027

Pin.13 1014

Pin.14 1012

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**F** 

ESD3.3V88D-0

Pin.4 SENSOR\_VP

Pin.5 SENSOR\_VN \_\_\_\_\_\_SENSOR\_VN

GPIO34

GPIO35

GPIO32

GPIO33

GPIO25

GPIO26

GPIO27

GPIO14

GPIO12

Pin.3 CHIP\_PU/EN

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Pin.38 GND

Pin.37 1023

Pin.36 1022

Pin.35 TXD0

Pin.34 RXD0

Pin.33 1021

Pin.32 NC

Pin.31 1019

Pin.30 IO18

Pin.29 105

Pin.28 1017

Pin.27 1016

Pin.26 104

Pin.25 100

**—** 

GN

GPIO2

UOTXD

GPIO2

GPIO1

GPI018

GPI05

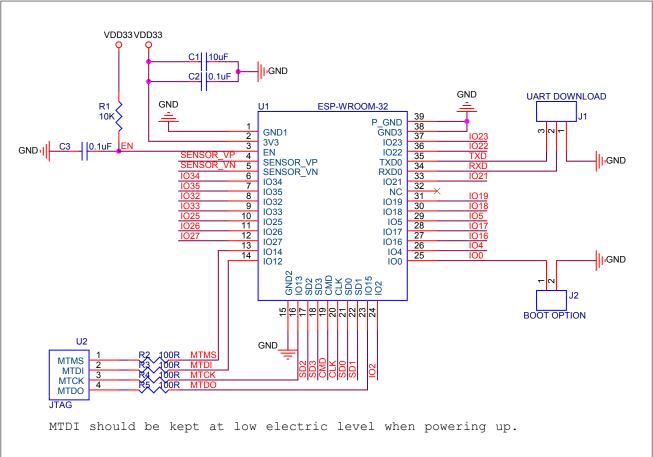
GPIO17

GPIO16

GPIO4

GPI00

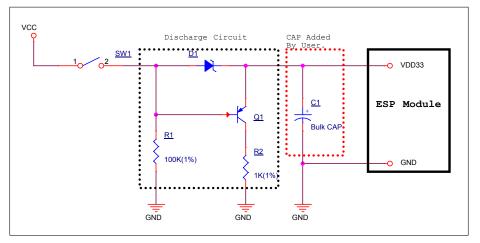
# 7. Peripheral Schematics



### Figure 4: ESP-WROOM-32 Peripheral Schematics

#### Note:

Soldering Pad 39 to the Ground of the base board is not necessary for a satisfactory thermal performance. If users do want to solder it, they need to ensure that the correct quantity of soldering paste is applied.



#### Figure 5: Discharge Circuit for VDD33 Rail

### Note:

The discharge circuit can be applied in scenarios where ESP32 is powered on and off repeatedly by switching the power rails, and there is a large capacitor on the VDD33 rail. For details, please refer to Section **Power Scheme** in <u>ESP32</u> Datasheet.

# 8. Dimensions



16.51±0.1

1.5

1.27±0.1

3.28

18.0±0.2

PCB width

15.8±0.1

0×10.

1.27±0.1

 $11.43 \pm 0.1$ 

7.6±0.1

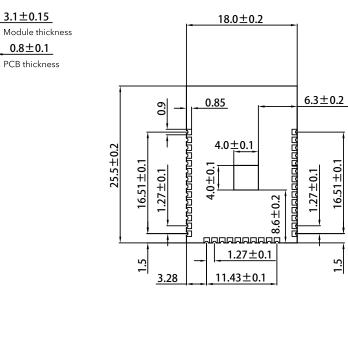
6.9

16.51±0.1

1.5

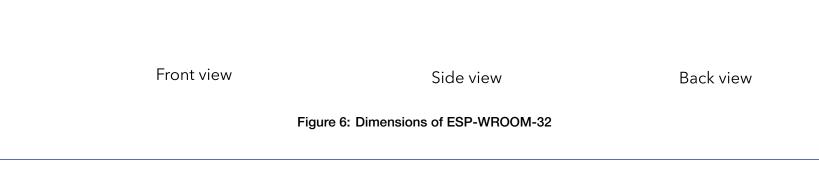
1.27±0.1

**25.5±0.2** PCB length



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Note:



All dimensions are in millimeters.

## 9. Learning Resources

### 9.1 Must-Read Documents

The following link provides documents related to ESP32.

ESP32 Datasheet

This document provides an introduction to the specifications of the ESP32 hardware, including overview, pin definitions, functional description, peripheral interface, electrical characteristics, etc.

- ESP32 Technical Reference Manual The manual provides detailed information on how to use the ESP32 memory and peripherals.
- ESP32 Hardware Resources

The zip files include the schematics, PCB layout, Gerber and BOM list of ESP32 modules and development boards.

• ESP32 Hardware Design Guidelines

The guidelines outline recommended design practices when developing standalone or add-on systems based on the ESP32 series of products, including ESP32, the ESP-WROOM-32 module, and ESP32-DevKitC—the development board.

#### ESP32 AT Instruction Set and Examples

This document introduces the ESP32 AT commands, explains how to use them, and provides examples of several common AT commands.

### 9.2 Must-Have Resources

Here are the ESP32-related must-have resources.

• ESP32 BBS

This is an Engineer-to-Engineer (E2E) Community for ESP32 where you can post questions, share knowledge, explore ideas, and help solve problems with fellow engineers.

• ESP32 GitHub

ESP32 development projects are freely distributed under Espressif's MIT license on GitHub. It is established to help developers get started with ESP32 and foster innovation and the growth of general knowledge about the hardware and software surrounding ESP32 devices.

ESP32 Tools

This is a webpage where users can download ESP32 Flash Download Tools and the zip file "ESP32 Certification and Test".

• ESP-IDF

This webpage links users to the official IoT development framework for ESP32.

ESP32 Resources

This webpage provides the links to all available ESP32 documents, SDK and tools.